

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	33	360/126.ccls. and ((insulation adj layer) same dielectric)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/07 12:56
L2	269	((dielectric or photoresist) same (apex adj angle))	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/07 12:58
L3	63	29/603\$.ccls. and ((dielectric or photoresist) same (apex adj angle))	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/07 12:58
L4	0	"360"/\$.ccls. and ((insulation and dielectric) same (milling adj rate) and (apex))	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/07 13:00
L5	0	"29"/\$.ccls. and ((insulation and dielectric) same (milling adj rate) and (apex))	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/07 13:00
S1	1513	360/126.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2004/02/19 09:52
S2	27	360/126.ccls. and ((insulation adj layer) same dielectric)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/07 12:56
S3	6	("4353102" "4422117" "4490760" "4636420" "4745506" "4875987").PN.	USPAT	OR	ON	2004/02/18 17:19
S4	6	29/603\$.ccls. and ((insulation and dielectric) same milli\$)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2004/02/19 09:59
S5	1831	29/603\$.ccls. or "360"/\$.ccls. and ((insulation and dielectric) same milliing adj rate)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2004/02/19 10:01
S6	1832	29/603\$.ccls. or "360"/\$.ccls. and ((insulation and dielectric) same milling adj rate)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2004/02/19 10:05

S7	1	"360"/\$.ccls. and ((insulation and dielectric) same milling adj rate)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/07 12:59
S8	0	29/603\$.ccls.and ((insulation and dielectric) same milling adj rate)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2004/02/19 10:06
S9	0	29/603\$.ccls. and ((insulation and dielectric) same milling adj rate)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2004/02/19 10:06
S10	1	((insulation and dielectric) same milling adj rate)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2004/02/19 10:06
S11	15	((insulation or dielectric) same milling adj rate)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2004/02/19 11:25
S12	0	((dielectric and photoresist) same milling adj rate)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2004/02/19 10:11
S13	50	((dielectric or photoresist) same milling adj rate)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/01/07 12:57
S14	3630	((dielectric or photoresist) same milling)	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2004/02/19 11:03
S15	3	"6150046".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2004/02/19 11:27
S16	2	"5935644".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2004/02/19 11:28